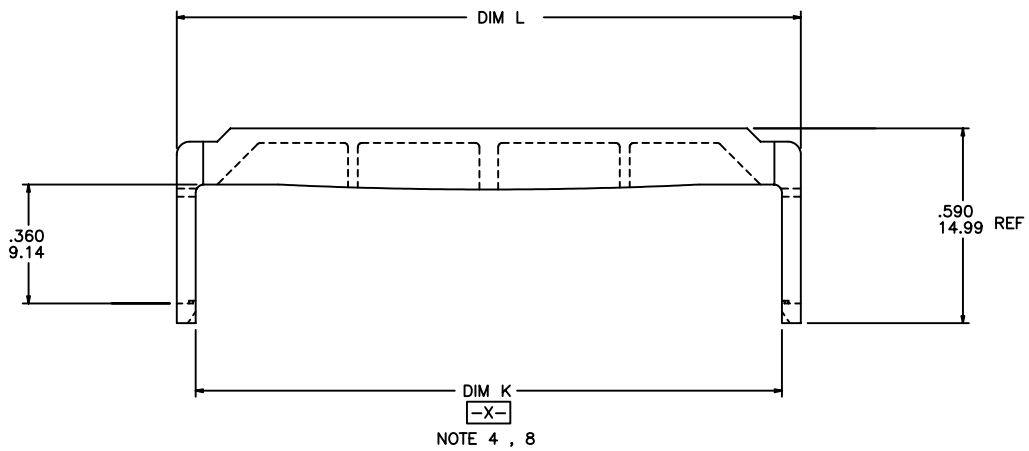
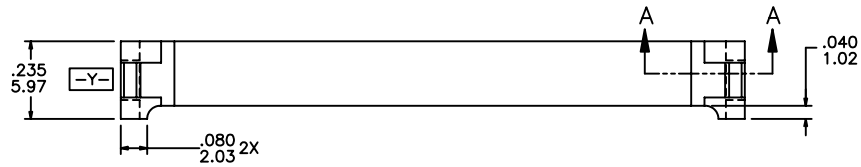
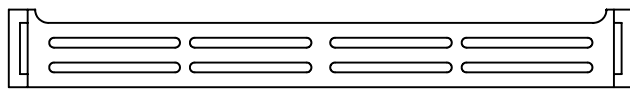
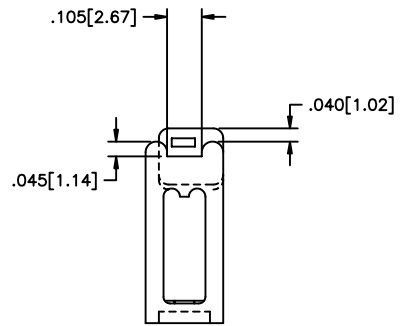


PRODUCT NUMBER

SEE TABLE



NOTE 4, 8



- NOTE:
- 1 ADD "LF" SUFFIX AT THE END OF PART NUMBER FOR LEAD FREE OPTION.
 - 2 IF "LF" P/N THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
 - 3 THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.

REVISIONS				SHEET INDEX	ISSUE		B		B												
REV	ECN/DDR#	BY	DATE		SH NO.	1	2														
A	NEW	DEW	5/22/89																		
B	V71195	SAR	10/1/97																		
C	N06-0112	LONG	4/18/06																		

TOLERANCES UNLESS OTHERWISE SPECIFIED	MAT	DR	D	WHITING	DATE	CUSTOMER COPY
.00±.01 / .00±.13	-	ENGR	M	SMYK	5/22/89	
LINEAR		CHK	M	SMYK	5/22/89	
.000±.005 / .00±.13	PRODUCT FAMILY	APPD	M	SMYK	5/22/89	
.0000±.0020 / .000±.051	QKE		M	SMYK	5/22/89	
ANGLES			M	SMYK	5/22/89	

BERG ELECTRONICS

TITLE: SPL STRAIN RELIEF QUICKIE II

SCALE: 5/11

SIZE: A

DWG. NO.: 6587311

SHEET: 1 OF 2

DATE: 5/11/06

APPD: M SMYK

STATUS: Released

FORM E-3067 REV 8/93

